As a below named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first, and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: "OPTIMIZATION METHODS FOR THE SYNTHESIS OF HIGHLY CONDUCTING AND TRANSPARENT THIN POLYMER FILMS", the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a). I hereby claim priority benefits under 35 United States Code Section 119 (e) for any provisional application listed below and have also identified below the priority date of filing of the provisional application which is before the filing date of the application for which this priority is claimed.

Prior Provisional Applications		P	riority Claimed			
				Yes	No	
I hereby claim foreign priority benefits unde- below any foreign application for patent or it	Title 35, United State	s Code, §119 of any	y foreign applications for profession	patent or inventor's ce	rtificate listed below and have also identified claimed:	
Number	Country		Filing Date		Priority (Yes/No)	
I hereby claim the benefit under Title 35, Un application is not disclosed in the prior Unite disclose material information as defined in international filing date of this application:	d States application in	the manner provide	ed by the first paragraph of	f title 35. United State	s Code, \$112. Lacknowledge the duty to	
U.S. Appl. Serial No.	U.S.	Filing Date		Status (pater	nted/pending/abandoned)	
POWER OF ATTORNEY: As a named inve Laboratory, Washington DC associated with therewith, and hereby certify that the Govern	Customer Number 26	384 to prosecute th	is application and to trans	act all business in the	Patent and Trademark Office connected	
SEND CORRESPONDENCE TO: Associate Counsel (Patents), Code 1008.2 Naval Research Laboratory Washington, D.C. 20375-5000						
I hereby declare that all statements made hen statements were made with the knowledge th United States Code, and that such willful fals	at willful false stateme:	nts and the like so r	nade are ounishable by fir	ne or imprisonment, or	are believed to be true; and further that these both, under Section 1001 of Title 18 of the	
FULL NAME OF JOINT INVENTOR 3: Sta	eve Political Control of the Political Control	21	DATE: / (117/03		
RESIDENCE: Silver Spring, MD CITIZENSHIP: USA POST OFFICE ADDRESS: 12601 Montelair	Dr., Silver Spring, MI	O 20904	DATE:	7.03	_	
FULL NAME OF JOINT INVENTOR 3: Br	ett D. Martin	<u></u>	11	117/03		
INVENTOR'S SIGNATURE: Bre	of money		DATE:	111193	_	
RESIDENCE: Washington, DC CITIZENSHIP: USA POST OFFICE ADDRESS: 1000 6 ^a SL SW,	Washington, DC 2002	4				

shir DATE: 11/19/03

FULL NAME OF JOINT INVENTOR 3: Ranganathan Shashidhar INVENTOR'S SIGNATURE:

RESIDENCE: Woodbridge, VA CITIZENSHIP: USA POST OFFICE ADDRESS: 1619 Heron Way, Woodbridge, VA 22191

FULL NAME OF JOINT INVENTOR 3, Yun	ng-Hoon Ha	
INVENTOR'S SIGNATURE:	917hv	DATE: 11/17/2003
RESIDENCE: Springfield, VA CITIZENSHIP: USA POST OFFICE ADDRESS: 6334 Dunn Court	Springfield, VA 22150	
1031 Office ADDRESS, 0334 Duni Comt	, Springrietu, VA 22130	
FULL NAME OF JOINT INVENTOR 3: Nik	olay Nikoloy	
INVENTOR'S SIGNATURE:	Juno 7	DATE: 11/17/2003

RESIDENCE: Woodbridge, VA CITIZENSHIP: USA POST OFFICE ADDRESS: 3612 Eagle Rock Court, Woodbridge, VA 22192